2.0 mm HM B-19 Right Angle Female

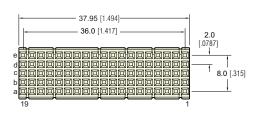


SPECIFICATION

- 1. Insulator Material: PBT 30% Glass filled UL 94 V-O
- Contact Material: Copper Alloy Shield Material: Copper Alloy 2. 3.
- 4.
 - Contact Plating: Contact Area: Gold Compliant Area: Matte Tin Performance: Class 1: 500 cycles Class 2: 250 cycles
- 6. Shield Plating: Contact Area: Gold
- Compliant Area: Matte Tin Temperature Range: -55 C to +125 C Contact Resistance: 20 M4Ohm Max. 7.
- 8.

- Contact Resistance: 20 MgOnin Max.
 Insulation Resistance: 10 M Ohm Max.
 Working Current: 1.5 ADC (Signal)
 Test Voltage: AC 750 V Min.
 Compliant Section: Insertion Force: 100 N per contact Max.

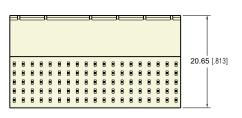
- Withdrawal Force: 20 N per contact Max.
 Withdrawal Force: 20 N per contact Min.
 13. Mating Force: .75 N per pin Max.
 14. Withdrawal Force: .15 N per pin Max.
 15. PCB Hole Size Requirements: Drilled Hole Diameter: 0.7 ± 0.02mm Einited Hole Diameter: 0.6 ± 0.05mm
- Finished Hole Diameter: 0.6 \pm 0.05mm 16. Recommended PCB Thickness: 1.6mm Min.
- 17. IEC 61076-4-101 Standard

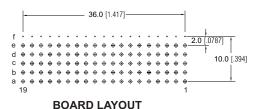


11.4 [.449]

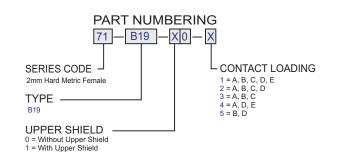
10.8 [.425]

3.0 [.118] --



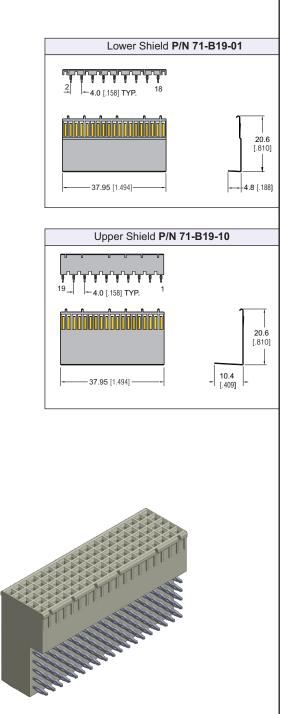






The **E-Z met** Type B-19 connector provides 95 contacts. These connectors are available either with or without integrated upper ground return shields. Lower ground return shields may be ordered separately.

The Type B-19 connector is used in the J3 position on the Compact PCI® daughtercard. This connector is not designed to be used alone, but may be used together with either a Type A, C, L, M or N E-Z met[™] connector.



Dimensions are in mm [inch]